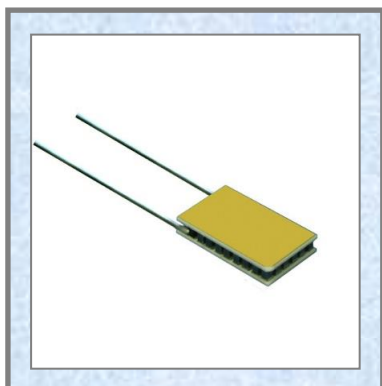


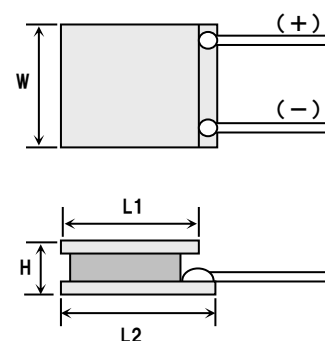
# THERMO MODULE DATA

Model **KSMH029** ( RoHS (EU) 2015/863 Compliant )



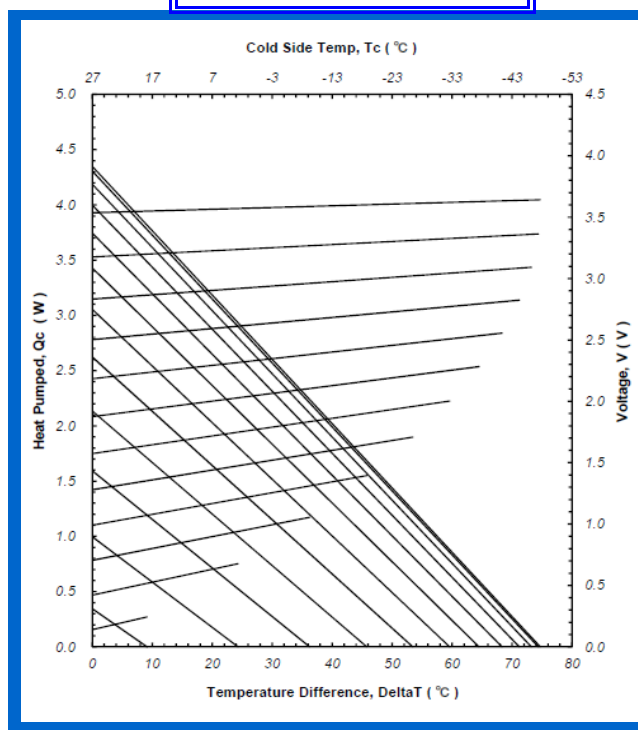
Th	$\Delta T_{max}(^{\circ}C)$	I <sub>max</sub> (A)	V <sub>max</sub> (v)	Q <sub>cmax</sub> (w)
27°C	75	2.3	3.6	4.3
70°C	92	2.3	4.5	4.8

	W	L1	L2	H
Size(mm)	6.0	10.2	10.2	1.65
Tolerance(mm)	±0.2	±0.2	±0.2	±0.1
Metallization	Cu-Ni-Au			
Ceramic material	Alumina			
Assembly solder	SnSb (melting point 232°C)			

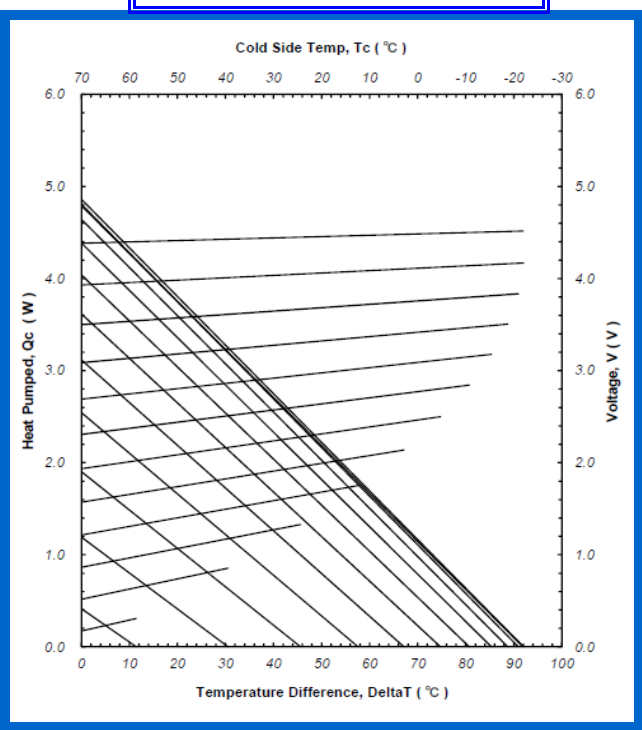


## Performance Diagram

Th=27°C



Th=70°C



Ambient

Nitrogen

Current value

I = 0.1 - 2.3 A ( Step = 0.2 A )

**KELK Ltd.**

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